



# MIDA 2026

第三届机器智能与数字化应用国际会议

3rd International Conference on Machine  
Intelligence and Digital Applications

会议日程

Conference Program



2026年4月24日 | April 24, 2026

中国西安 (线上) | Xi'an, China (Online)

# 大会简介

第三届机器智能与数字化应用国际会议

3rd International Conference on Machine Intelligence and Digital Applications

第三届机器智能与数字化应用国际会议 (3rd International Conference on Machine Intelligence and Digital Applications) 将于 2026 年 4 月 24 日在西安 (线上) 召开。

本届会议得到法国上阿尔萨斯大学、东北大学等国内外高校的大力支持, 以“机器智能与数字化应用”为主题, 旨在为相关领域的专家、学者及专业技术人员提供一个交流最新研究成果的平台。

# Introduction

第三届机器智能与数字化应用国际会议

3rd International Conference on Machine Intelligence and Digital Applications

The 3rd International Conference on Machine Intelligence and Digital Applications (MIDA 2026) will take place on April 24, 2026, in Xi'an, China (Online). As an annual event, MIDA 2026 aims to provide an interactive platform for discussing the advancements in machine intelligence, digital applications, and related fields. The conference invites participants from around the world who are interested in forging professional connections or exploring career opportunities in the region. It will serve as an ideal forum for sharing insights and experiences.

# 组织单位

## 第三届机器智能与数字化应用国际会议

3rd International Conference on Machine Intelligence and Digital Applications

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Shanwen Zhang, Xijing University, China

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# 会议日程/Program

第三届机器智能与数字化应用国际会议

3rd International Conference on Machine Intelligence and Digital Applications

日期 / Date: 2026 年 04 月 24 日 (周五) | April 24, 2026 (Friday)

时区 / Time zone: UTC+8:00, 北京时间 | UTC+8:00, Beijing Time

腾讯会议室入会链接 / VooV Meeting Link: <https://voovmeeting.com/dm/0BFk2ozzrbge>

腾讯会议室入会 ID / VooV Meeting ID: 387-325-344

Time / 时间	Program / 日程
09:00-09:10	<b>Opening Ceremony / 开幕致辞</b>
09:10-09:40	<b>Keynote Speech 1 / 主讲报告 1:</b> Prof. Xinguo Yu, Central China Normal University, China / 华中师范大学
09:40-10:10	<b>Keynote Speech 2 / 主讲报告 2:</b> Prof. Victor Chang Aston University, UK / 英国阿斯顿大学
10:10-10:40	<b>Keynote Speech 3 / 主讲报告 3:</b> Prof. Huiyu Zhou University of Leicester, UK / 英国莱斯特大学
10:40-11:10	<b>Keynote Speech 4 / 主讲报告 4:</b> Dr. Francesco Mercaldo University of Molise, Italy / 意大利莫利塞大学
11:10-11:40	<b>Keynote Speech 5 / 主讲报告 5:</b> Assoc. Prof. Pooja Singh SIES- Graduate School of Technology, India / 印度孟买大学附属 SIES 技术研 究生院
11:40-12:00	<b>Oral Presentation</b>

14:00-18:00

**Oral Presentation**

